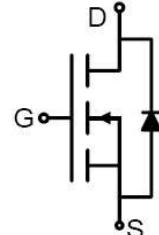


Feature

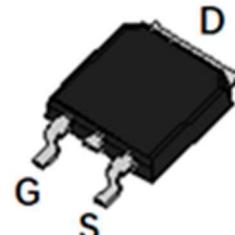
- 100V,50A
- $R_{DS\ (ON)} < 16m\ \Omega @ V_{GS}=10V$ (TYP:14m Ω)
- Split Gate Trench Technology
- Lead free product is acquired
- Excellent $R_{DS\ (ON)}$ and Low Gate Charge



Schematic Diagram

Application

- PWM applications
- Load Switch
- Power management



TO-252(DPAK) top view

Package Marking and Ordering Information

| Device Marking | Device | Device Package | Reel Size | Tape width | Quantity (PCS) |
|----------------|---------|----------------|-----------|------------|----------------|
| 1310 | AP1310K | TO-252 | 13 inch | - | 2500 |

ABSOLUTE MAXIMUM RATINGS ($T_a=25^\circ C$ unless otherwise noted)

| Parameter | Symbol | Value | Unit |
|--|-----------------|----------|--------------|
| Drain-Source Voltage | V_{DS} | 100 | V |
| Gate-Source Voltage | V_{GS} | ± 20 | V |
| Continuous Drain Current ($T_a = 25^\circ C$) | I_D | 50 | A |
| Continuous Drain Current ($T_a = 100^\circ C$) | I_D | 31.5 | A |
| Pulsed Drain Current ⁽¹⁾ | I_{DM} | 200 | A |
| Singel Pulsed Avalanche Energy ⁽²⁾ | E_{AS} | 32 | mJ |
| Power Dissipation | P_D | 68 | W |
| Thermal Resistance from Junction to Ambient | $R_{\theta JA}$ | 55 | $^\circ C/W$ |
| Junction Temperature | T_J | 150 | $^\circ C$ |
| Storage Temperature | T_{STG} | -55~+150 | $^\circ C$ |

MOSFET ELECTRICAL CHARACTERISTICS($T_a=25^\circ C$ unless otherwise noted)

| Parameter | Symbol | Test Condition | Min | Type | Max | Unit |
|---|---------------|---|-----|------|-----------|-----------|
| Static Characteristics | | | | | | |
| Drain-source breakdown voltage | $V_{(BR)DSS}$ | $V_{GS} = 0V, I_D = 250\mu A$ | 100 | - | - | V |
| Zero gate voltage drain current | I_{DSS} | $V_{DS} = 80V, V_{GS} = 0V$ | - | - | 1 | μA |
| Gate-body leakage current | I_{GSS} | $V_{GS} = \pm 20V, V_{DS} = 0V$ | - | - | ± 100 | nA |
| Gate threshold voltage ⁽³⁾ | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_D = 250\mu A$ | 1.2 | 1.8 | 2.5 | V |
| Drain-source on-resistance ⁽³⁾ | $R_{DS(on)}$ | $V_{GS} = 10V, I_D = 20A$ | - | 14 | 16 | $m\Omega$ |
| | | $V_{GS} = 4.5V, I_D = 10A$ | - | 18.5 | 23 | |
| Forward Threshold Voltage | g_{fs} | $V_{DS} = 5V, I_D = 20A$ | - | 13.5 | - | S |
| Gate Resistance | R_g | $V_{DS} = V_{GS} = 0V, f = 1MHz$ | - | 1.44 | - | Ω |
| Dynamic characteristics | | | | | | |
| Input Capacitance | C_{iss} | $V_{DS} = 25V, V_{GS} = 0V, f = 1MHz$ | - | 1130 | - | pF |
| Output Capacitance | C_{oss} | | - | 496 | - | |
| Reverse Transfer Capacitance | C_{rss} | | - | 60 | - | |
| Switching characteristics | | | | | | |
| Turn-on delay time | $t_{d(on)}$ | $V_{DD} = 50V, I_D = 20A,$ $V_{GS} = 10V, R_G = 3\Omega$ | - | 46 | - | ns |
| Turn-on rise time | t_r | | - | 55 | - | |
| Turn-off delay time | $t_{d(off)}$ | | - | 249 | - | |
| Turn-off fall time | t_f | | - | 105 | - | |
| Total Gate Charge | Q_g | $V_{DS} = 50V, I_D = 20A,$ $V_{GS} = 10V$ | - | 30 | - | nC |
| Gate-Source Charge | Q_{gs} | | - | 6 | - | |
| Gate-Drain Charge | Q_{gd} | | - | 8.2 | - | |
| Reverse Recovery Charge | Q_{rr} | $I_F = 20A, di/dt = 100A/us$ | | 224 | | nC |
| Reverse Recovery Time | T_{rr} | $I_F = 20A, di/dt = 100A/us$ | | 70 | | ns |
| Source-Drain Diode characteristics | | | | | | |
| Diode Forward voltage ⁽³⁾ | V_{DS} | $V_{GS} = 0V, I_s = 20A$ | - | - | 1.2 | V |
| Diode Forward current ⁽⁴⁾ | I_s | | - | - | 50 | A |

Notes:

1. Repetitive Rating: pulse width limited by maximum junction temperature
2. EAS Condition: $T_J = 25^\circ C, V_{DD} = 50V, R_G = 25\Omega, L = 0.5mH$
3. Pulse Test: pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$
4. Surface Mounted on FR4 Board, $t \leq 10$ sec

Typical Performance Characteristics

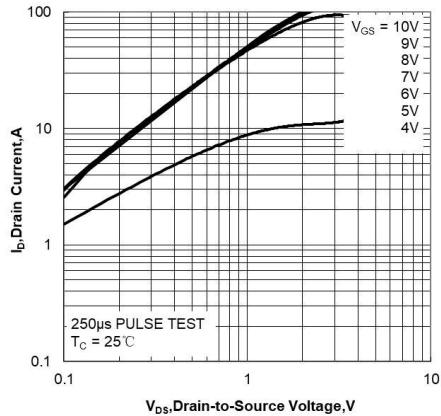


Figure 1. Output Characteristics

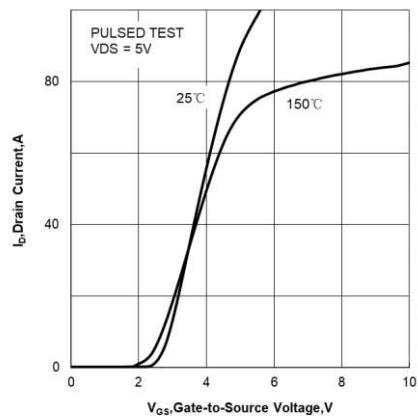
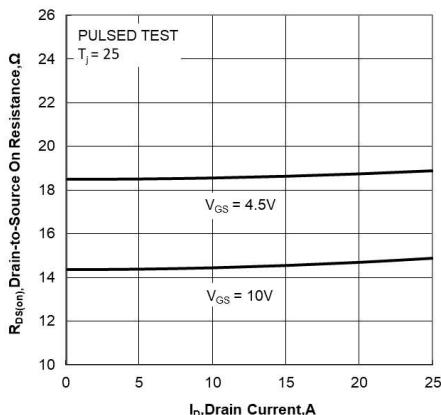
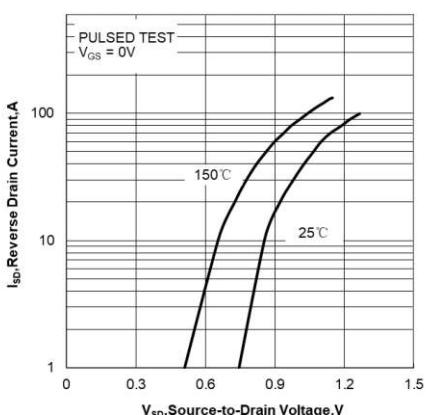


Figure 2. Transfer Characteristics



**Figure 3. Drain-to-Source On Resistance
vs Drain Current**



**Figure 4. Body Diode Forward Voltage
vs Source Current and Temperature**

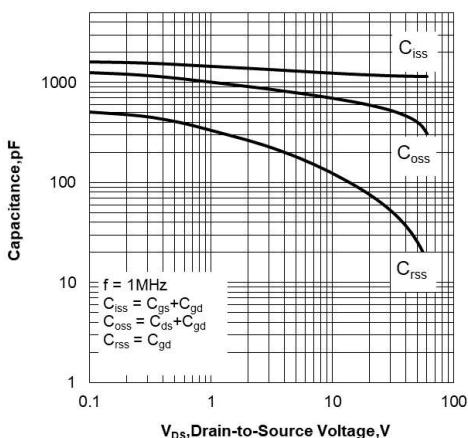


Figure 5. Capacitance Characteristics

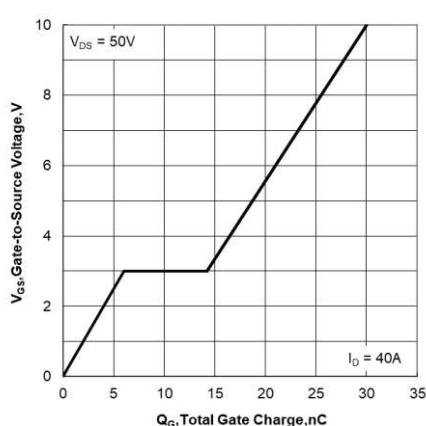
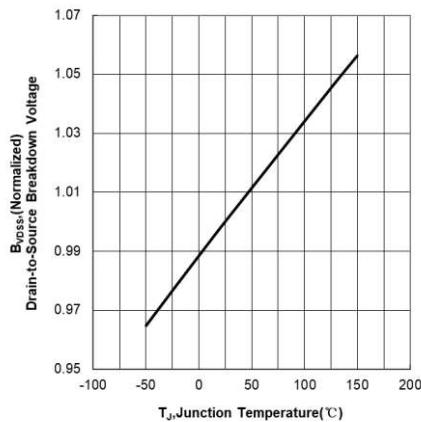
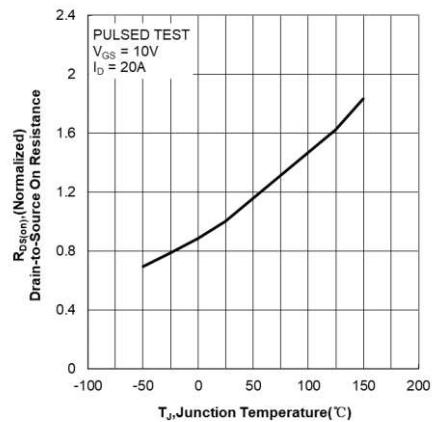


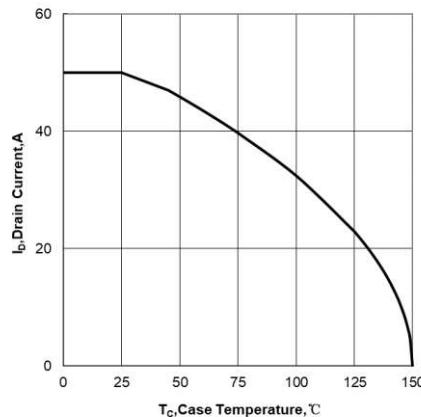
Figure 6. Gate Charge Characteristics



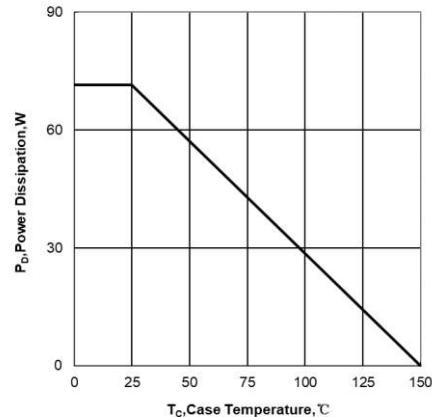
**Figure 7. Normalized Breakdown Voltage
vs Junction Temperature**



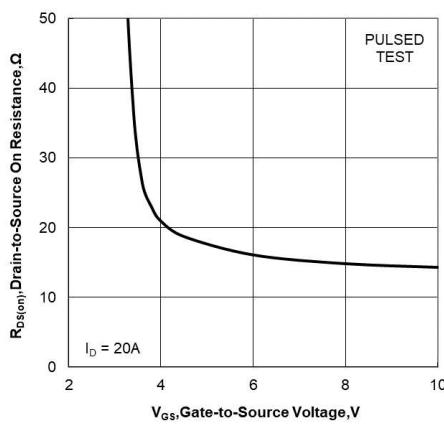
**Figure 8. Normalized On Resistance vs
Junction Temperature**



**Figure 9. Maximum Continuous Drain Current
vs Case Temperature**



**Figure 10. Maximum Power Dissipation
vs Case Temperature**



**Figure11. Drain-to-Source On Resistance vs Gate
Voltage and Drain Current**

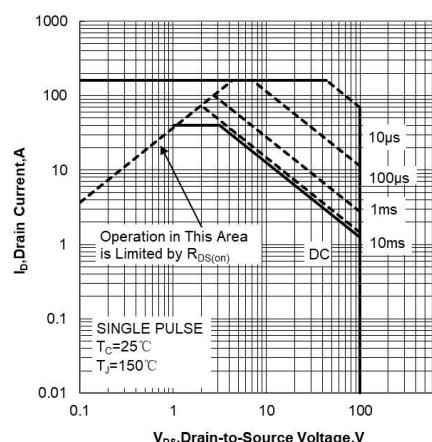


Figure 12. Maximum Safe Operating Area

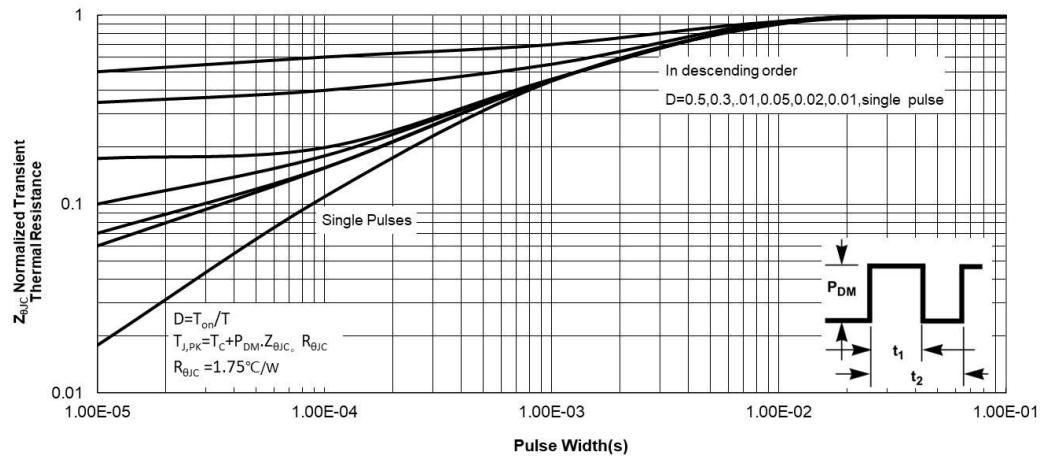
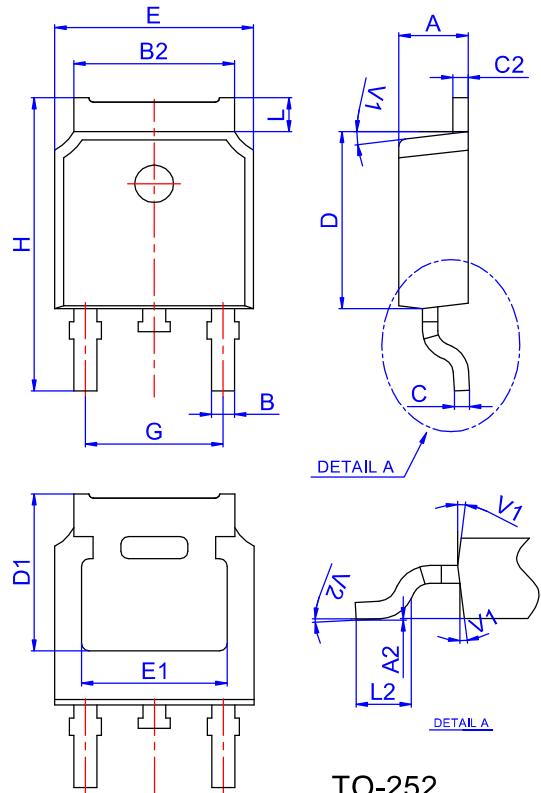


Figure 13. Maximum Effective Transient Thermal Impedance, Junction-to-Case

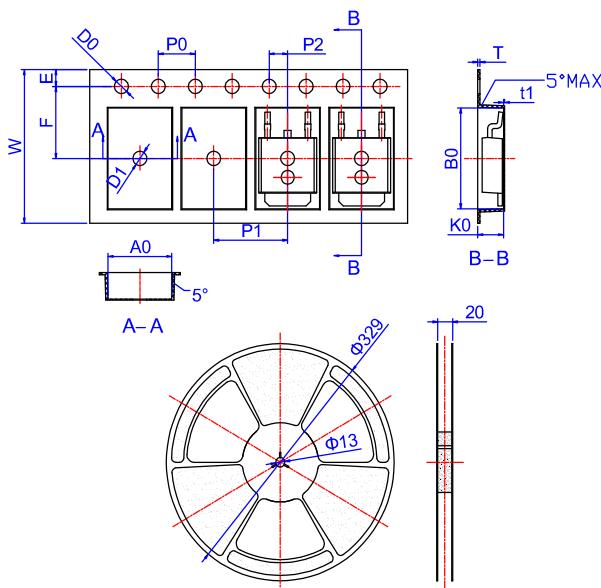
TO-252 Package Information



TO-252

| Ref. | Dimensions | | | | | |
|------|-------------|------|------|----------|-------|------|
| | Millimeters | | | Inches | | |
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| A | 2.10 | | | 2.50 | 0.083 | |
| A2 | 0 | | | 0.10 | 0 | |
| B | 0.66 | | | 0.86 | 0.026 | |
| B2 | 5.18 | | | 5.48 | 0.202 | |
| C | 0.40 | | | 0.60 | 0.016 | |
| C2 | 0.44 | | | 0.58 | 0.017 | |
| D | 5.90 | | | 6.30 | 0.232 | |
| D1 | 5.30REF | | | 0.209REF | | |
| E | 6.40 | | | 6.80 | 0.252 | |
| E1 | 4.63 | | | | 0.182 | |
| G | 4.47 | | | 4.67 | 0.176 | |
| H | 9.50 | | | 10.70 | 0.374 | |
| L | 1.09 | | | 1.21 | 0.043 | |
| L2 | 1.35 | | | 1.65 | 0.053 | |
| V1 | | 7° | | | | 7° |
| V2 | 0° | | | 6° | 0° | |
| | | | | | | 6° |

Reel Specification-TO-252



| Ref. | Dimensions | | | | | |
|------|-------------|-------|-------|--------|-------|-------|
| | Millimeters | | | Inches | | |
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| W | 15.90 | 16.00 | 16.10 | 0.626 | 0.630 | 0.634 |
| E | 1.65 | 1.75 | 1.85 | 0.065 | 0.069 | 0.073 |
| F | 7.40 | 7.50 | 7.60 | 0.291 | 0.295 | 0.299 |
| D0 | 1.40 | 1.50 | 1.60 | 0.055 | 0.059 | 0.063 |
| D1 | 1.40 | 1.50 | 1.60 | 0.055 | 0.059 | 0.063 |
| P0 | 3.90 | 4.00 | 4.10 | 0.154 | 0.157 | 0.161 |
| P1 | 7.90 | 8.00 | 8.10 | 0.311 | 0.315 | 0.319 |
| P2 | 1.90 | 2.00 | 2.10 | 0.075 | 0.079 | 0.083 |
| A0 | 6.85 | 6.90 | 7.00 | 0.270 | 0.271 | 0.276 |
| B0 | 10.45 | 10.50 | 10.60 | 0.411 | 0.413 | 0.417 |
| K0 | 2.68 | 2.78 | 2.88 | 0.105 | 0.109 | 0.113 |
| T | 0.24 | | | 0.27 | 0.009 | |
| t1 | 0.10 | | | | 0.004 | |
| 10P0 | 39.80 | 40.00 | 40.20 | 1.567 | 1.575 | 1.583 |

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[IPS70R2K0CEAKMA1](#) [BSF024N03LT3 G](#) [PSMN4R2-30MLD](#) [TK31J60W5,S1VQ\(O](#) [2SK2614\(TE16L1,Q\)](#) [DMN1017UCP3-7](#)
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